

May 2006

Features

- Single 5 volt supply
- Programmable μ -law/A-law Codec and filters
- Fully differential output driver
- SSI digital interface
- SSI speed control via external pins CSLO-CSL2
- Individual transmit and receive mute controls
- 0 dB gain in receive path
- 6 dB gain in transmit path
- Low power operation
- ITU-T G.714 compliant

Applications

- Cellular radio sets
- Local area communications stations
- Line cards

Ordering Information

MT9162AE	20 Pin PDIP	Tubes
MT9162AS	20 Pin SOIC	Tubes
MT9162AN	20 Pin SSOP	Tubes
MT9162AN1	20 Pin SSOP*	Tubes

*Pb Free Matte Tin

-40°C to +85°C

Description

The MT9162 5 V single rail Codec incorporates a built-in Filter/Codec, transmit anti-alias filter, a reference voltage and bias source. The device supports both A-law and μ -law requirements.

The analog interface is capable of driving a 20 k ohm load.

The MT9162 is fabricated in Zarlink's ISO²-CMOS technology ensuring low power consumption and high reliability.

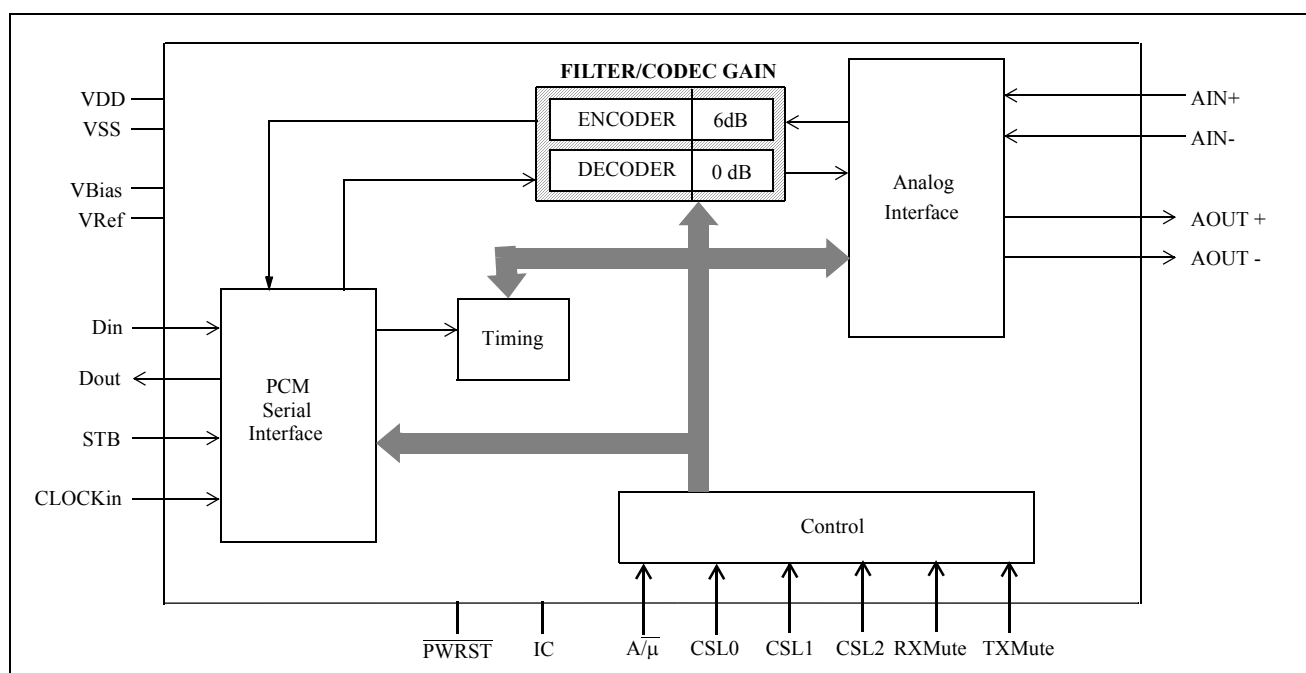
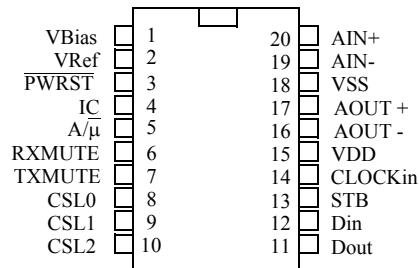


Figure 1 - Functional Block Diagram



20 PIN PDIP/SOIC/SSOP

Figure 2 - Pin Connections

Pin Description

Pin #	Name	Description
1	V _{Bias}	Bias Voltage (Output). ($V_{DD}/2$) volts is available at this pin for biasing external amplifiers. Connect 0.1 μ F capacitor to V _{SS} . Connect 1 μ F capacitor to Vref.
2	V _{Ref}	Reference Voltage for Codec (Output). Nominally $[(V_{DD}/2)-1.9]$ volts. Used internally. Connect 0.1 μ F capacitor to V _{SS} . Connect 1 μ F capacitor to VBias
3	PWRST	Power-up Reset. Resets internal state of device via Schmitt Trigger input (active low).
4	IC	Internal Connection. Tie externally to V _{SS} for normal operation.
5	A/ $\bar{\mu}$	A/$\bar{\mu}$ Law Selection. CMOS level compatible input pin governs the companding law used by the device. A-law selected when pin tied to V _{DD} or μ -law selected when pin tied to V _{SS} .
6	RXMute	Receive Mute. When 1, the transmit PCM is forced to negative zero code. When 0, normal operation. CMOS level compatible.
7	TXMute	Transmit Mute. When 1, the transmit PCM is forced to negative zero code. When 0, normal operation. CMOS level compatible.
8 9 10	CSL0 CSL1 CSL2	Clock Speed Select. These pins are used to program the speed of the SSI mode as well as the conversion rate between the externally supplied MCL clock and the 512 kHz clock required by the filter/codec. Refer to Table 2 for details. CMOS level compatible.
11	D _{out}	Data Output. A tri-state digital output for 8-bit wide channel data being sent to the Layer 1 device. Data is shifted out via the pin concurrent with the rising edge of BCL during the timeslot defined by STB.
12	D _{in}	Data Input. A digital input for 8-bit wide data from the layer 1 device. Data is sampled on the falling edge of BCL during the timeslot defined by STB. CMOS level compatible.
13	STB	Data Strobe. This input determines the 8-bit timeslot used by the device for both transmit and receive data. This active high signal has a repetition rate of 8 kHz. CMOS level compatible.
14	CLOCKin	Clock (Input). The clock provided to this input pin is used by the internal device functions. Connect bit clock to this pin when it is 512 kHz or greater. Connect a 4096 kHz clock to this pin when the bit clock is 128 kHz or 256 kHz. CMOS level compatible.
15	V _{DD}	Positive Power Supply. Nominally 5 volts.

Pin Description (continued)

Pin #	Name	Description
16	AOUT-	Inverting Analog Output. (balanced).
17	AOUT+	Non-Inverting Analog Output. (balanced).
18	V _{SS}	Ground. Nominally 0 volts.
19	Ain-	Inverting Analog Input. No external anti-aliasing is required.
20	Ain+	Non-Inverting Analog Input. Non-inverting input. No external anti-aliasing is required.

Overview

The 5 V single rail Codec features complete Analog/Digital and Digital/Analog conversion of audio signals (Filter/Codec) and an analog interface to a standard analog transmitter and receiver (Analog Interface). The receiver amplifier is capable of driving a 20 k ohm load.

Functional Description**Filter/Codec**

The Filter/Codec block implements conversion of the analog 0-3.3 kHz speech signals to/from the digital domain compatible with 64 kb/s PCM B-Channels. Selection of companding curves and digital code assignment are programmable. These are ITU-T G.711 A-law or μ -Law, with true-sign/Alternate Digit Inversion.

The Filter/Codec block also implements a transmit audio path gain in the analog domain. Figure 3 depicts the nominal half-channel for the MT9162.

The internal architecture is fully differential to provide the best possible noise rejection as well as to allow a wide dynamic range from a single 5 volt supply design. This fully differential architecture is continued into the analog interface section to provide full chip realization of these capabilities for the external functions.

A reference voltage (V_{Ref}), for the conversion requirements of the Codec section, and a bias voltage (V_{Bias}), for biasing the internal analog sections, are both generated on-chip. V_{Bias} is also brought to an external pin so that it may be used for biasing external gain setting amplifiers. A 0.1 μ F capacitor must be connected from V_{Bias} to analog ground at all times. Likewise, although V_{Ref} may only be used internally, a 0.1 μ F capacitor from the V_{Ref} pin to ground is required at all times. The analog ground reference point for these two capacitors must be physically the same point. To facilitate this the V_{Ref} and V_{Bias} pins are situated on adjacent pins.

The transmit filter is designed to meet ITU-T G.714 specifications. An anti-aliasing filter is included. This is a second order lowpass implementation with a corner frequency at 25 kHz.

The receive filter is designed to meet ITU-T G.714 specifications. Filter response is peaked to compensate for the $\sin x/x$ attenuation caused by the 8 kHz sampling rate.

Companding law selection for the Filter/Codec is provided by the A/ $\bar{\mu}$ companding control pin. Table 1 illustrates these choices.

Code	ITU-T (G.711)	
	μ -Law	A-Law
+ Full Scale	1000 0000	1010 1010
+ Zero	1111 1111	1101 0101
-Zero (quiet code)	0111 1111	0101 0101
- Full Scale	0000 0000	0010 1010

Table 1 - Law Selection**Analog Interfaces**

Standard interfaces are provided by the MT9162. These are:

- The analog inputs (transmitter), pins AIN+/AIN-. The maximum peak to peak input is 3.667Vpp μ -law and across AIN+/AIN- 3.8Vpp A-law.
- The analog outputs (receiver), pins AOUT+/AOUT-. This internally compensated fully differential output driver is capable of driving a load of 20k ohms.

PCM Serial Interface

A serial link is required to transport data between the MT9162 and an external digital transmission device. The MT9162 utilizes the strobed data interface found on many standard Codec devices. This interface is commonly referred to as Simple Serial Interface (SSI).

The required mode of operation is selected via the CSL2-0 control pins. See Table 2 for selections based in CSL2-0 pin settings.

Quiet Code

The PCM serial port can be made to send quiet code to the decoder and receive filter path by setting the RxMute pin high. Likewise, the PCM serial port will send quiet code in the transmit path when the

CSL ₂	CSL ₁	CSL ₀	External Clock Bit Rate (kHz)	CLOCKin (kHz)
1	0	0	128	4096
1	0	1	256	4096
0	0	0	512	512
0	0	1	1536	1536
0	1	0	2048	2048
0	1	1	4096	4096

Figure 2 - Table 2: Bit Clock Rate Selection

TxMute pin is high. When either of these pins are low their respective paths function normally. The -Zero entry of Table 1 is used for the quiet code definition.

SSI Mode

The SSI BUS consists of input and output serial data streams named Din and Dout respectively, a Clock input signal (CLOCKin), and a framing strobe input (STB). A 4.096 MHz master clock is also required for SSI operation if the bit clock is less than 512 kHz. The timing requirements for SSI are shown in Figures 5 & 6.

In SSI mode the MT9162 supports only B-Channel operation. Hence, in SSI mode transmit and receive B-Channel data are always in the channel defined by the STB input.

The data strobe input STB determines the 8-bit timeslot used by the device for both transmit and receive data. This is an active high signal with an 8 kHz repetition rate.

SSI operation is separated into two categories based upon the data rate of the available bit clock. If the bit clock is 512 kHz or greater then it is used directly by the internal MT9162 functions allowing synchronous operation. If the available bit clock is 128 kHz or 256 kHz, then a 4096 kHz master clock is required to derive clocks for the internal MT9162 functions.

Applications where Bit Clock (BCL) is below 512 kHz are designated as asynchronous. The MT9162 will re-align its internal clocks to allow operation when the external master and bit clocks are asynchronous. Control pins CSL2, CSL1 and CSL0 are used to program the bit rates.

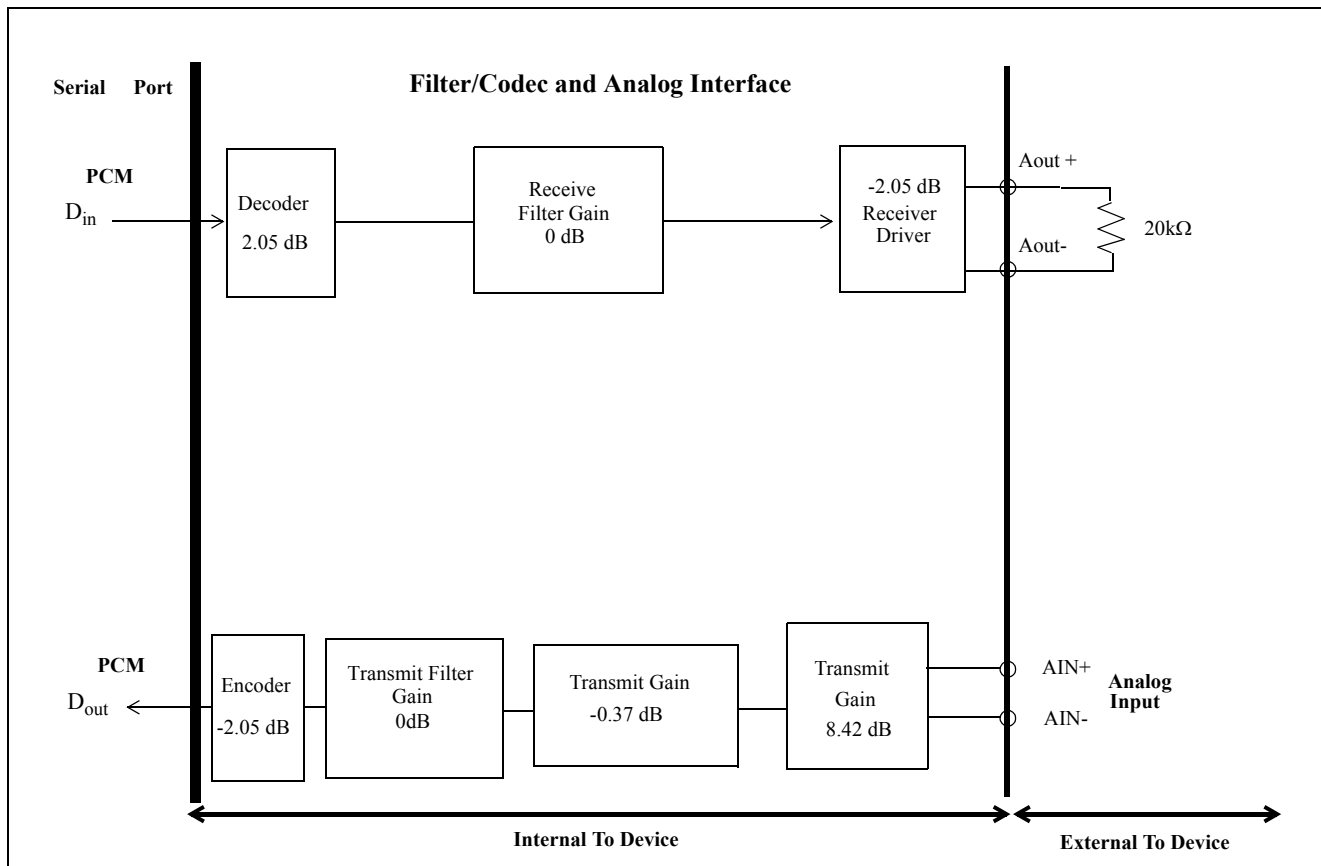


Figure 3 - Audio Gain Partitioning

For synchronous operation, data is sampled from Din, on the falling edge of BCL during the time slot defined by the STB input. Data is made available, on Dout, on the rising edge of BCL during the time slot defined by the STB input. Dout is tri-stated at all times when STB is not true. If STB is valid, then quiet code will be transmitted on Dout during the valid strobe period. There is no frame delay through the PCM serial circuit for synchronous operation.

For asynchronous operation Dout and Din are as defined for synchronous operation except that the allowed output jitter on Dout is larger. This is due to the resynchronization circuitry activity and will not affect operation since the bit cell period at 128 kb/s and 256 kb/s is relatively large. There is a one frame delay through the PCM serial circuit for asynchronous operation. Refer to the specifications of Figures 5 & 6 for both synchronous and asynchronous SSI timing.

PWRST

While the MT9162 is held in $\overline{\text{PWRST}}$ no device control or functionality is possible.

Applications

Figure 4 shows the MT9162 in a line card application.

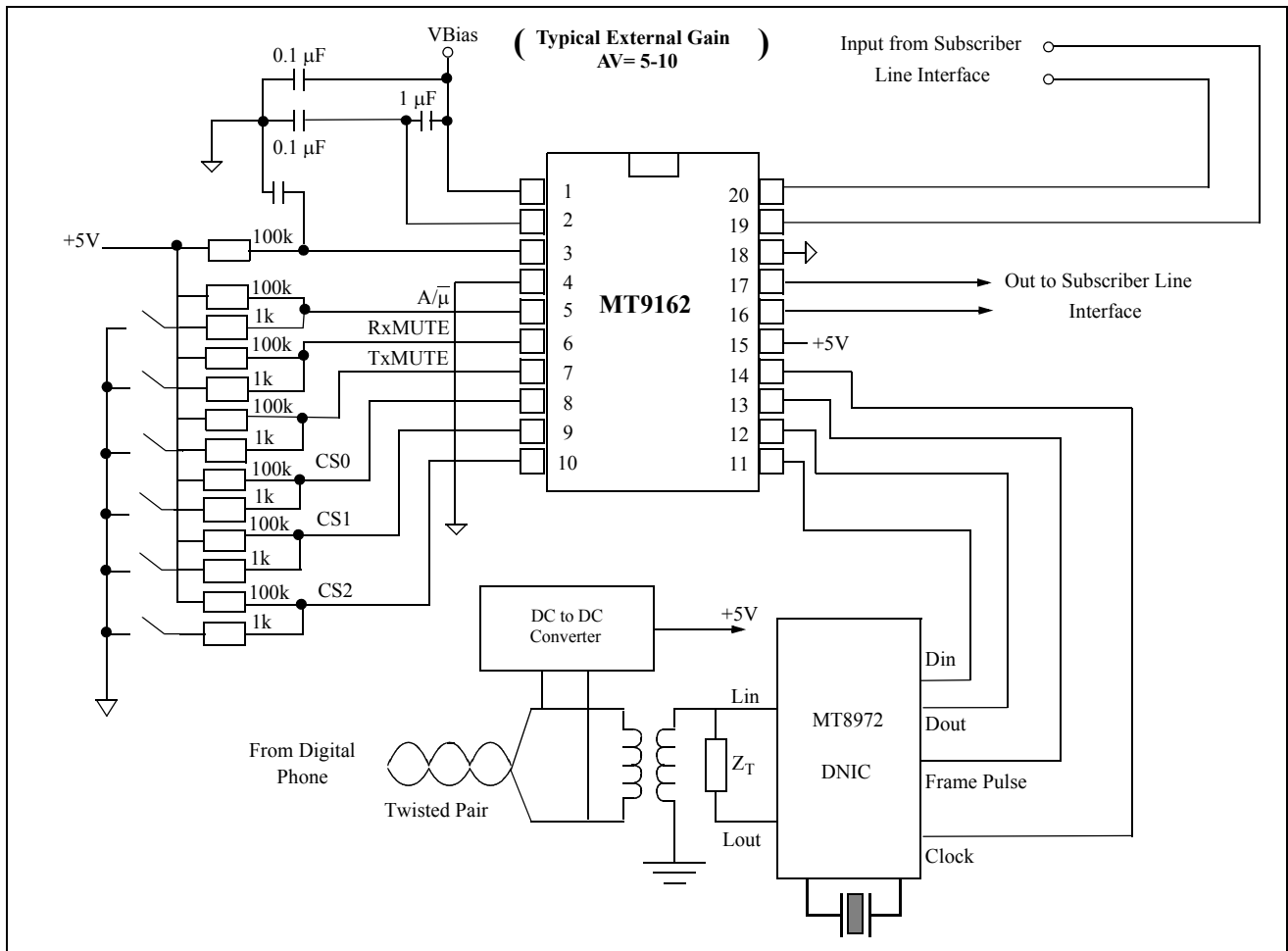


Figure 4 - Line Card Application

Absolute Maximum Ratings[†]

	Parameter	Symbol	Min.	Max.	Units
1	Supply Voltage	$V_{DD} - V_{SS}$	- 0.3	7	V
2	Voltage on any I/O pin	V_I/V_O	$V_{SS} - 0.3$	$V_{DD} + 0.3$	V
3	Current on any I/O pin (transducers excluded)	I_I/I_O		± 20	mA
4	Storage Temperature	T_S	- 65	+ 150	°C
5	Power Dissipation (package)	P_D		750	mW

[†] Exceeding these values may cause permanent damage. Functional operation under these conditions is not implied.

Recommended Operating Conditions - Voltages are with respect to V_{SS} unless otherwise stated

	Characteristics	Sym.	Min.	Typ.	Max.	Units	Test Conditions
1	Supply Voltage	V_{DD}	4.75	5	5.25	V	
2	CMOS Input Voltage (high)	V_{IHC}	4.5		V_{DD}	V	
3	CMOS Input Voltage (low)	V_{ILC}	V_{SS}		0.5	V	
4	Operating Temperature	T_A	- 40		+ 85	°C	

Power Characteristics

	Characteristics	Sym.	Min.	Typ.	Max.	Units	Test Conditions
1	Static Supply Current (clock disabled)	I_{DDC1}		4	20	μA	Outputs unloaded, Input signals static, not loaded
2	Dynamic Supply Current: Total all functions enabled	I_{DDFT}		7.0	10	mA	See Note 1

Note 1: Power delivered to the load is in addition to the bias current requirements.

DC Electrical Characteristics[†] - Voltages are with respect to ground (V_{SS}) unless otherwise stated.

	Characteristics	Sym.	Min.	Typ. [‡]	Max.	Units	Test Conditions
1	Input HIGH Voltage CMOS inputs	V_{IHC}	3.5			V	
2	Input LOW Voltage CMOS inputs	V_{ILC}			1.5	V	
3	VBias Voltage Output	V_{Bias}		$V_{DD}/2$		V	Max. Load = 10k Ω
4	V_{Ref} Output Voltage	V_{Ref}		$V_{DD}/2-1.9$		V	No load
5	Input Leakage Current	I_{IZ}		0.1	10	μA	$V_{IN}=V_{DD}$ to V_{SS}
6	Positive Going Threshold Voltage (PWRST only) Negative Going Threshold Voltage (PWRST only)	V_{T+} V_{T-}	3.7		1.3	V V	
7	Output HIGH Current	I_{OH}	3	7		mA	$V_{OH} = 0.9*V_{DD}$ See Note 1
8	Output LOW Current	I_{OL}	5	10		mA	$V_{OL} = 0.1*V_{DD}$ See Note 1
9	Output Leakage Current	I_{OZ}		0.01	10	μA	$V_{OUT} = V_{DD}$ and V_{SS}
10	Output Capacitance	C_o		15		pF	
11	Input Capacitance	C_i		10		pF	

[†] DC Electrical Characteristics are over recommended temperature range & recommended power supply voltages.

[‡] Typical figures are at 25 °C and are for design aid only; not guaranteed and not subject to production testing.

* Note 1 - Magnitude measurement, ignore signs.

Clockin Tolerance Characteristics[†]

	Characteristics	Min.	Typ. [‡]	Max.	Units	Test Conditions
1	CLOCKin Frequency (Asynchronous Mode)	4095.6	4096	4096.4	kHz	(i.e., 100 ppm)

[†] AC Electrical Characteristics are over recommended temperature range & recommended power supply voltages.

[‡] Typical figures are at 25 °C and are for design aid only; not guaranteed and not subject to production testing.

AC Characteristics[†] for A/D (Transmit) Path - $0\text{dBm0} = A_{\text{Lo3.17}} - 3.17\text{dB} = 1.773V_{\text{rms}}$ for μ -Law and
 $-3.14\text{dB} = 1.843V_{\text{rms}}$ for A-Law, at the Codec. ($V_{\text{Ref}}=0.6$ volts and $V_{\text{Bias}}=2.5$ volts.)

$0\text{dBm0} = A_{\text{Lo3.14}}$

	Characteristics	Sym.	Min.	Typ. [‡]	Max.	Units	Test Conditions
1	Analog input equivalent to overload decision	$A_{\text{Li3.17}}$ $A_{\text{Li3.14}}$		7.334 7.6		Vp-p Vp-p	μ -Law A-Law Both at Codec
2	Absolute half-channel gain $A_{\text{IN}} \pm$ to D_{out}	G_{AX1}	5.2	6.0	6.8	dB	Transmit filter gain=0dB setting. @1020Hz
3	Gain tracking vs. input level ITU-T G.714 Method 2	G_{TX}	-0.3 -0.6 -1.6		0.3 0.6 1.6	dB dB dB	3 to -40 dBm0 -40 to -50 dBm0 -50 to -55 dBm0
4	Signal to total Distortion vs. input level. ITU-T G.714 Method 2	D_{QX}	35 29 24			dB dB dB	0 to -30 dBm0 -40 dBm0 -45 dBm0
5	Transmit Idle Channel Noise	N_{CX} N_{PX}		8.5 -71	12 -69	dBmC0 dBm0p	μ -Law A-Law
6	Gain relative to gain at <50Hz 60Hz 200Hz 300 - 3000 Hz 3000 - 3400 Hz 4000 Hz >4600 Hz	G_{RX}		-45 -0.25 -0.9 -23 -40	-25 -30 0.0 0.25 0.25 -12.5 -25	dB dB dB dB dB dB dB	
7	Absolute Delay	D_{AX}		360		μs	at frequency of minimum delay
8	Group Delay relative to D_{AX}	D_{DX}		750 380 130 750		μs μs μs μs	500-600 Hz 600 - 1000 Hz 1000 - 2600 Hz 2600 - 2800 Hz
9	Power Supply Rejection $f=1020$ Hz $f=0.3$ to 3 kHz $f=3$ to 4 kHz $f=4$ to 50 kHz	PSSR PSSR1 PSSR2 PSSR3	37	37 40 35 40		dB dB dB dB	$\pm 100\text{mV}$ peak signal on V_{DD} μ -law PSSR1-3 not production tested

[†] AC Electrical Characteristics are over recommended temperature range & recommended power supply voltages.

[‡] Typical figures are at 25 °C and are for design aid only: not guaranteed and not subject to production testing.

AC Characteristics[†] for D/A (Receive) Path - $0\text{dBm0} = A_{\text{Lo3.17}} - 3.17\text{dB} = 1.773V_{\text{rms}}$ for $\mu\text{-Law}$ and
 $-3.14\text{dB} = 1.843V_{\text{rms}}$ for A-Law , at the Codec. ($V_{\text{Ref}}=0.6$ volts and $V_{\text{Bias}}=2.5$ volts.)

$0\text{dBm0} = A_{\text{Lo3.14}}$

	Characteristics	Sym.	Min.	Typ. [‡]	Max.	Units	Test Conditions
1	Analog output at the Codec full scale	$A_{\text{Lo3.17}}$ $A_{\text{Lo3.14}}$		7.225 7.481		Vp-p Vp-p	$\mu\text{-Law}$ A-Law
2	Absolute half-channel gain. $\text{Din to AOUT}\pm$	G_{AR1}	-0.8	0	0.8	dB	@1020Hz
3	Gain tracking vs. input level ITU-T G.714 Method 2	G_{TR}	-0.3 -0.6 -1.6		0.3 0.6 1.6	dB dB dB	3 to -40 dBm0 -40 to -50 dBm0 -50 to -55 dBm0
4	Signal to total distortion vs. input level. ITU-T G.714 Method 2	G_{QR}	35 29 24			dB dB dB	0 to -30 dBm0 -40 dBm0 -45 dBm0
5	Receive Idle Channel Noise	N_{CR} N_{PR}		7 -84	10 -80	dBmC0 dBm0p	$\mu\text{-Law}$ A-Law
6	Gain relative to gain at 1020Hz 200Hz 300 - 3000 Hz 3000 - 3400 Hz 4000 Hz >4600 Hz	G_{RR}	-0.25 -0.90		0.25 0.25 0.25 -12.5 -25	dB dB dB dB dB	
7	Absolute Delay	D_{AR}		240		μs	at frequency of min. delay
8	Group Delay relative to D_{AR}	D_{DR}		750 380 130 750		μs μs μs μs	500-600 Hz 600 - 1000 Hz 1000 - 2600 Hz 2600 - 2800 Hz
9	Crosstalk D/A to A/D A/D to D/A	CT_{RT} CT_{TR}			-74 -80	dB dB	G.714.16 ITU-T

[†] AC Electrical Characteristics are over recommended temperature range & recommended power supply voltages.

[‡] Typical figures are at 25 °C and are for design aid only: not guaranteed and not subject to production testing.

Electrical Characteristics[†] for Analog Outputs

	Characteristics	Sym.	Min.	Typ. [‡]	Max.	Units	Test Conditions
1	Load impedance at Output	E_{ZL}	20k			ohms	across $\text{AOUT}\pm$
2	Allowable output capacitive load	E_{CL}		20		pF	each pin: $\text{AOUT}+$, $\text{AOUT}-$
3	Analog output harmonic distortion	E_{D}			0.5	%	20k ohms load across $\text{AOUT}\pm$ $\text{VO} \leq 693\text{mV}_{\text{RMS}}$

[†] Electrical Characteristics are over recommended temperature range & recommended power supply voltages.

[‡] Typical figures are at 25 °C and are for design aid only: not guaranteed and not subject to production testing.

Electrical Characteristics[†] for Analog Inputs

	Characteristics	Sym.	Min.	Typ. [‡]	Max.	Units	Test Conditions
1	Maximum input voltage without overloading Codec across AIN+/AIN-	V_{IOLH}		2.90 3.00		V _{p-p}	$A/\mu = 0$ $A/\mu = 1$
2	Input Impedance	Z_I	50			k Ω	AIN+/AIN- to V _{SS}

[†] Electrical Characteristics are over recommended temperature range & recommended power supply voltages.

[‡] Typical figures are at 25 °C and are for design aid only; not guaranteed and not subject to production testing.

AC Electrical Characteristics[†] - SSI BUS Synchronous Timing (see Figure 5)

	Characteristics	Sym.	Min.	Typ. [‡]	Max.	Units	Test Conditions
1	BCL Clock Period	t_{BCL}	244		1953	ns	BCL=4096 kHz to 512 kHz
2	BCL Pulse Width High	t_{BCLH}		122		ns	BCL=4096 kHz
3	BCL Pulse Width Low	t_{BCLL}		122		ns	BCL=4096 kHz
4	BCL Rise/Fall Time	t_R/t_F		20		ns	Note 1
5	Strobe Pulse Width	t_{ENW}		8 x t_{BCL}		ns	Note 1
6	Strobe setup time before BCL falling	t_{SSS}	70		t_{BCL-80}	ns	
7	Strobe hold time after BCL falling	t_{SSH}	80		t_{BCL-80}	ns	
8	Dout High Impedance to Active Low from Strobe rising	t_{DOZL}			50	ns	$C_L=150$ pF, $R_L=1K$
9	Dout High Impedance to Active High from Strobe rising	t_{DOZH}			50	ns	$C_L=150$ pF, $R_L=1K$
10	Dout Active Low to High Impedance from Strobe falling	t_{DOLZ}			50	ns	$C_L=150$ pF, $R_L=1K$
11	Dout Active High to High Impedance from Strobe falling	t_{DOHZ}			50	ns	$C_L=150$ pF, $R_L=1K$
12	Dout Delay (high and low) from BCL rising	t_{DD}			50	ns	$C_L=150$ pF, $R_L=1K$
13	Din Setup time before BCL falling	t_{DIS}	20			ns	
14	Din Hold Time from BCL falling	t_{DIH}	50			ns	

[†] Timing is over recommended temperature range & recommended power supply voltages.

[‡] Typical figures are at 25°C and are for design aid only; not guaranteed and not subject to production testing.

NOTE 1: Not production tested, guaranteed by design.

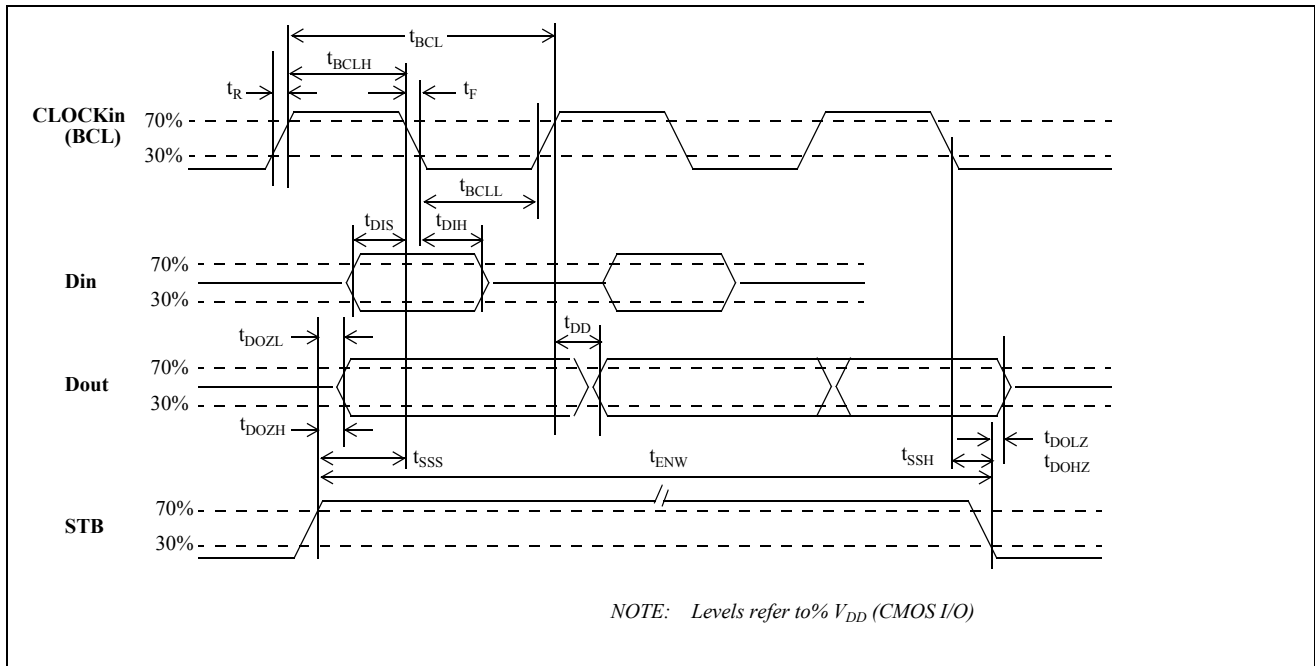


Figure 5 - SSI Synchronous Timing Diagram

AC Electrical Characteristics[†] - SSI BUS Asynchronous Timing (note 1) (see Figure 6)

	Characteristics	Sym.	Min.	Typ. [‡]	Max.	Units	Test Conditions
1	Bit Cell Period	T_{DATA}		7812 3906		ns ns	BCL=128 kHz BCL=256 kHz
2	Frame Jitter	T_j			600	ns	
3	Bit 1 Dout Delay from STB going high	t_{dda1}			T_j+600	ns	$C_L=150$ pF, $R_L=1K$
4	Bit 2 Dout Delay from STB going high	t_{dda2}	600+ $T_{DATA}-T_j$	600+ T_{DATA}	600 + $T_{DATA}+T_j$	ns	$C_L=150$ pF, $R_L=1K$
5	Bit n Dout Delay from STB going high	t_{ddan}	600 + (n-1) x $T_{DATA}-T_j$	600 + (n-1) x T_{DATA}	600 + (n-1) x $T_{DATA}+T_j$	ns	$C_L=150$ pF, $R_L=1K$ n=3 to 8
6	Bit 1 Data Boundary	T_{DATA1}	$T_{DATA}-T_j$		$T_{DATA}+T_j$	ns	
7	Din Bit n Data Setup time from STB rising	t_{SU}	$T_{DATA}/2$ +500ns- T_j +(n-1) x T_{DATA}			ns	n=1-8
8	Din Data Hold time from STB rising	t_{ho}	$T_{DATA}/2$ +500ns+ T_j +(n-1) x T_{DATA}			ns	

[†] Timing is over recommended temperature range & recommended power supply voltages.

[‡] Typical figures are at 25°C and are for design aid only: not guaranteed and not subject to production testing.

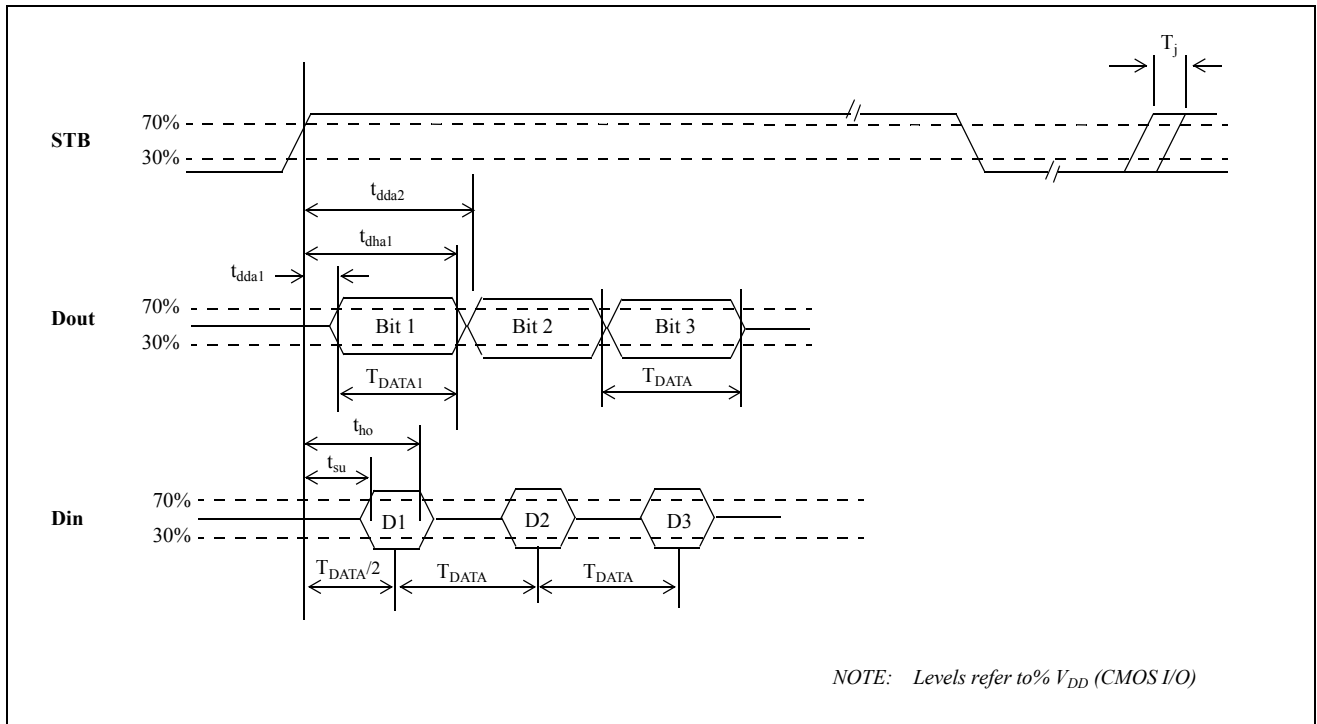
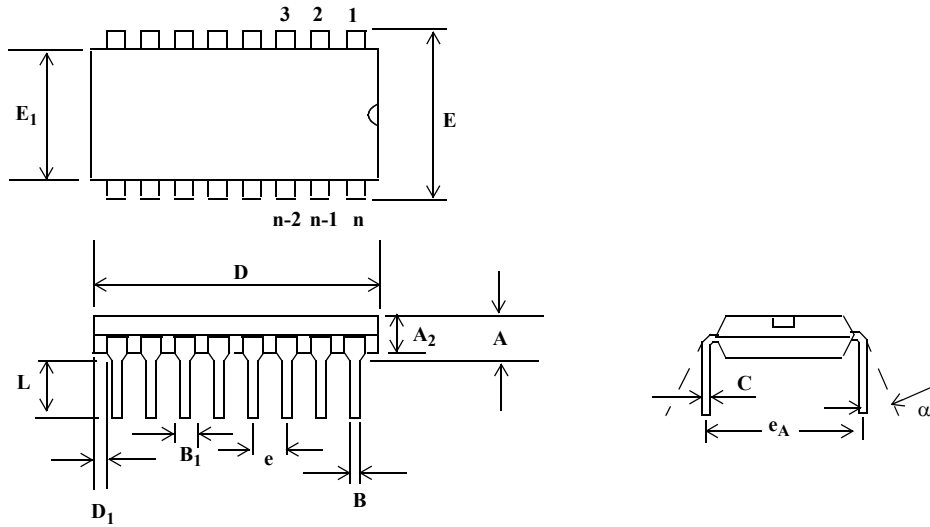


Figure 6 - SSI Asynchronous Timing Diagram



Notes:

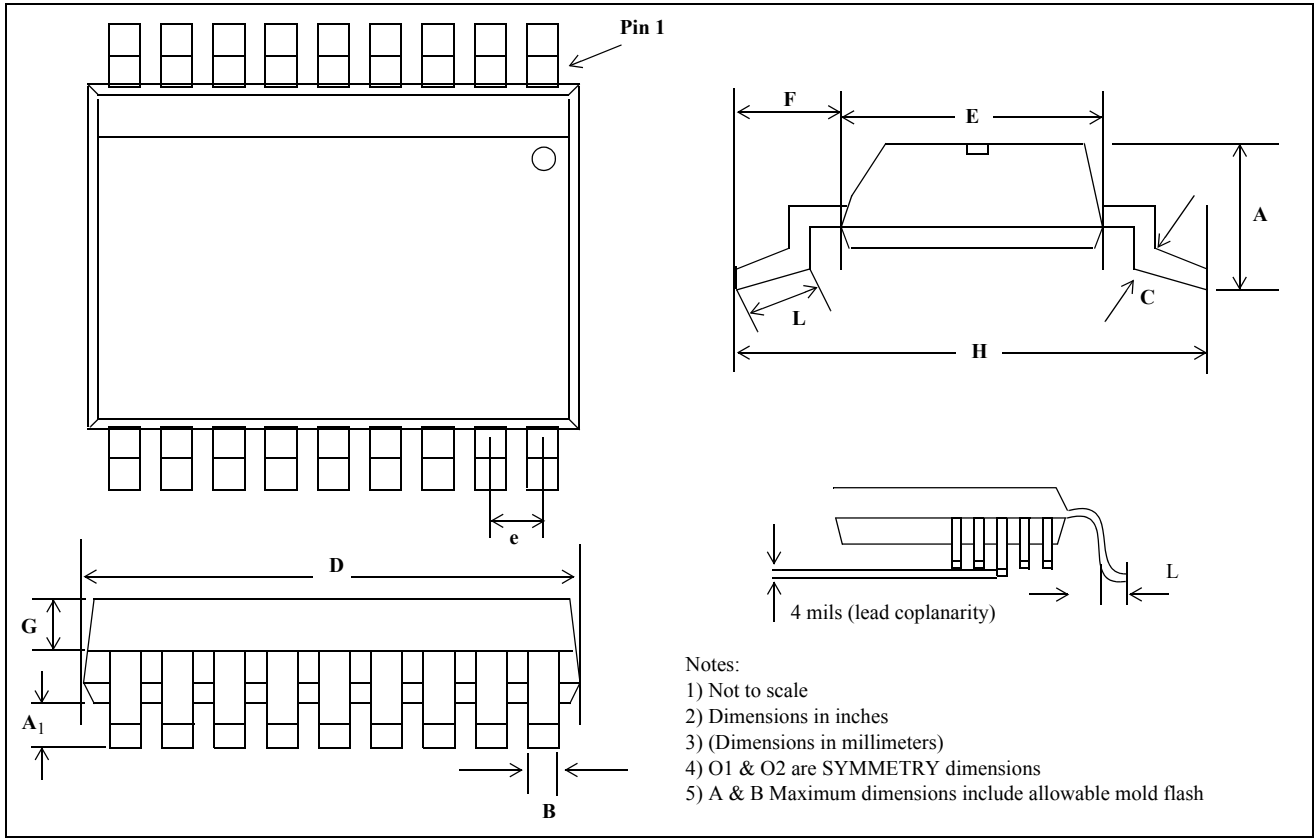
- 1) Not to scale
- 2) Dimensions in inches
- 3) (Dimensions in millimeters)

Plastic Dual-In-Line Packages (PDIP) - E Suffix

DIM	8-Pin		16-Pin		18-Pin		20-Pin	
	Plastic		Plastic		Plastic		Plastic	
	Min	Max	Min	Max	Min	Max	Min	Max
A		0.210 (5.33)		0.210 (5.33)		0.210 (5.33)		0.210 (5.33)
A_2	0.115 (2.93)	0.195 (4.95)	0.115 (2.93)	0.195 (4.95)	0.115 (2.93)	0.195 (4.95)	0.115 (2.93)	0.195 (4.95)
B	0.014 (0.356)	0.022 (0.558)	0.014 (0.356)	0.022 (0.558)	0.014 (0.356)	0.022 (0.558)	0.014 (0.356)	0.022 (0.558)
B_1	0.045 (1.15)	0.070 (1.77)	0.045 (1.15)	0.070 (1.77)	0.045 (1.15)	0.070 (1.77)	0.045 (1.15)	0.070 (1.77)
C	0.008 (0.204)	0.015 (0.381)	0.008 (0.204)	0.015 (0.381)	0.008 (0.204)	0.015 (0.381)	0.008 (0.204)	0.015 (0.381)
D	0.348 (8.84)	0.430 (10.92)	0.745 (18.93)	0.840 (21.33)	0.845 (21.47)	0.925 (23.49)	0.925 (23.49)	1.060 (26.9)
D_1	0.005 (0.13)		0.005 (0.13)		0.005 (0.13)		0.005 (0.13)	
E	0.290 (7.37)	0.330 (8.38)	0.290 (7.37)	0.330 (8.38)	0.290 (7.37)	0.330 (8.38)	0.290 (7.37)	0.330 (8.38)
E_1	0.240 (6.10)	0.280 (7.11)	0.240 (6.10)	0.280 (7.11)	0.240 (6.10)	0.280 (7.11)	0.240 (6.10)	0.280 (7.11)
e	0.100 BSC (2.54)		0.100 BSC (2.54)		0.100 BSC (2.54)		0.100 BSC (2.54)	
e_1								
e_A	0.300 BSC (7.62)		0.300 BSC (7.62)		0.300 BSC (7.62)		0.300 BSC (7.62)	
L	0.115 (2.93)	0.160 (4.06)	0.115 (2.93)	0.160 (4.06)	0.115 (2.93)	0.160 (4.06)	0.115 (2.93)	0.160 (4.06)

DIM	8-Pin		16-Pin		18-Pin		20-Pin	
	Plastic		Plastic		Plastic		Plastic	
	Min	Max	Min	Max	Min	Max	Min	Max
S								
a		15°		15°		15°		15°

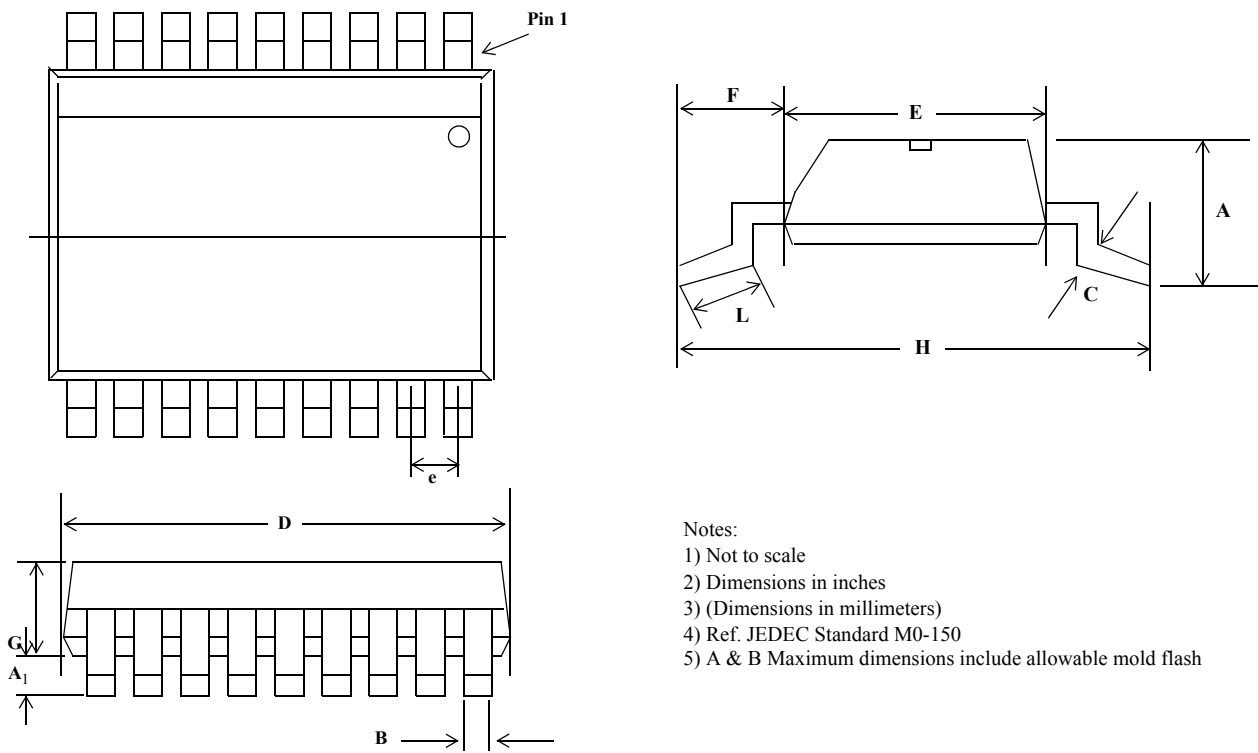
NOTE: () Millimeters



DIM	16-Pin		18-Pin		20-Pin		24-Pin		28-Pin	
	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max
A	0.093 (2.35)	0.104 (2.65)	0.093 (2.35)	0.104 (2.65)	0.093 (2.35)	0.104 (2.65)	0.093 (2.35)	0.104 (2.65)	0.093 (2.35)	0.104 (2.65)
A ₁	0.004 (0.10)	0.012 (0.30)	0.004 (0.10)	0.012 (0.30)	0.004 (0.10)	0.012 (0.30)	0.004 (0.10)	0.012 (0.30)	0.004 (0.10)	0.012 (0.30)
B	0.014 (0.351)	0.019 (0.488)	0.014 (0.351)	0.019 (0.488)	0.014 (0.351)	0.019 (0.488)	0.014 (0.351)	0.019 (0.488)	0.014 (0.351)	0.019 (0.488)
C	0.009 (0.231)	0.013 (0.318)	0.009 (0.231)	0.013 (0.318)	0.009 (0.231)	0.013 (0.318)	0.009 (0.231)	0.013 (0.318)	0.009 (0.231)	0.013 (0.318)
D	0.398 (10.1)	0.413 (10.5)	0.447 (11.35)	0.469 (11.90)	0.496 (12.60)	0.518 (13.00)	0.598 (15.2)	0.614 (15.6)	0.697 (17.7)	0.712 (18.1)
E	0.291 (7.40)	0.305 (7.75)	0.291 (7.40)	0.305 (7.75)	0.291 (7.40)	0.305 (7.75)	0.291 (7.40)	0.305 (7.75)	0.291 (7.40)	0.305 (7.75)
e	0.050 BSC (1.27 BSC)		0.050 BSC (1.27 BSC)		0.050 BSC (1.27 BSC)		0.050 BSC (1.27 BSC)		0.050 BSC (1.27 BSC)	
F	0.044 (1.125)	0.064 (1.625)	0.044 (1.125)	0.064 (1.625)	0.044 (1.125)	0.064 (1.625)	0.044 (1.125)	0.064 (1.625)	0.044 (1.125)	0.064 (1.625)

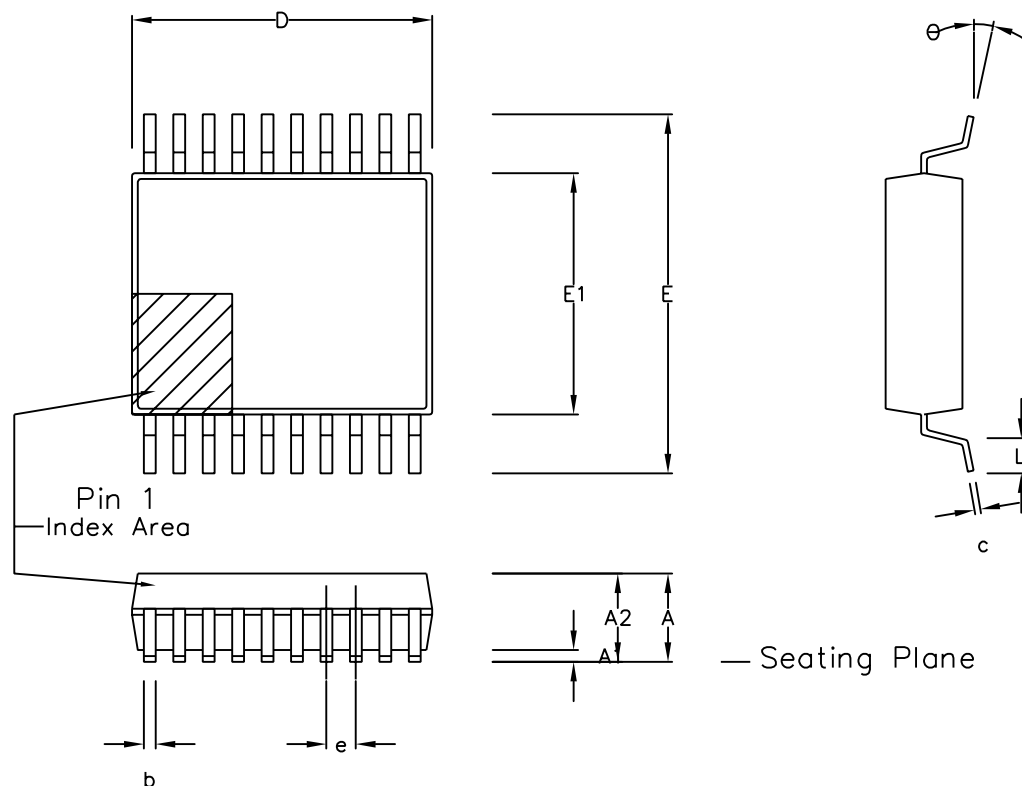
DIM	16-Pin		18-Pin		20-Pin		24-Pin		28-Pin	
	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max
G	0.040 (1.016)	0.050 (1.270)	0.040 (1.016)	0.050 (1.270)	0.040 (1.016)	0.050 (1.270)	0.040 (1.016)	0.050 (1.270)	0.040 (1.016)	0.050 (1.270)
H	0.394 (10.00)	0.419 (10.65)	0.394 (10.00)	0.419 (10.65)	0.394 (10.00)	0.419 (10.65)	0.394 (10.00)	0.419 (10.65)	0.394 (10.00)	0.419 (10.65)
L	0.016 (0.40)	0.050 (1.27)	0.016 (0.40)	0.050 (1.27)	0.016 (0.40)	0.050 (1.27)	0.016 (0.40)	0.050 (1.27)	0.016 (0.40)	0.050 (1.27)

Lead SOIC Package - S Suffix



Dim	20-Pin		24-Pin		28-Pin		48-Pin	
	Min	Max	Min	Max	Min	Max	Min	Max
A		0.079 (2)	-	0.079 (2)		0.079 (2)	0.095 (2.41)	0.110 (2.79)
A ₁	0.004 (0.1)		0.004 (0.1)		0.004 (0.1)		0.008 (0.2)	0.015 (0.4)
B	0.0087 (0.22)	0.013 (0.33)	0.0087 (0.22)	0.013 (0.33)	0.0087 (0.22)	0.013 (0.33)	0.008 (0.2)	0.0135 (0.34)
C		0.008 (0.21)		0.008 (0.21)		0.008 (0.21)		0.010 (0.25)
D	0.27 (6.9)	0.295 (7.5)	0.31 (7.9)	0.33 (8.5)	0.39 (9.9)	0.41 (10.5)	0.62 (15.75)	0.63 (16.00)
E	0.2 (5.0)	0.22 (5.6)	0.2 (5.0)	0.22 (5.6)	0.2 (5.0)	0.22 (5.6)	0.291 (7.39)	0.299 (7.59)
e	0.025 BSC (0.65 BSC)		0.025 BSC (0.65 BSC)		0.025 BSC (0.65 BSC)		0.025 BSC (0.65 BSC)	
F	0.049 REF (1.25 REF)		0.049 REF (1.25 REF)		0.049 REF (1.25 REF)		0.056 REF (1.42 REF)	
G	0.065 (1.65)	0.073 (1.85)	0.065 (1.65)	0.073 (1.85)	0.065 (1.65)	0.073 (1.85)	0.089 (2.25)	0.099 (2.52)
H	0.29 (7.4)	0.32 (8.2)	0.29 (7.4)	0.32 (8.2)	0.29 (7.4)	0.32 (8.2)	0.395 (10.03)	0.42 (10.67)
L	0.022 (0.55)	0.037 (0.95)	0.022 (0.55)	0.037 (0.95)	0.022 (0.55)	0.037 (0.95)	0.02 (0.51)	0.04 (1.02)

Small Shrink Outline Package (SSOP) - N Suffix



Symbol	Control Dimensions in millimetres				Altern. Dimensions in inches		
	MIN	Nominal	MAX		MIN	Nominal	MAX
A	1.70		2.00		0.067		0.079
A1	0.05		0.20		0.002		0.008
A2	1.65		1.85		0.065		0.073
D	6.90		7.50		0.272		0.295
E	7.40		8.20		0.291		0.323
E1	5.00		5.60		0.197		0.220
L	0.55		0.95		0.022		0.037
e	0.65 BSC.				0.026 BSC.		
b	0.22		0.38		0.009		0.015
c	0.09		0.25		0.004		0.010
θ	0°		8°		0°		8°
	Pin features						
N	20						
Conforms to JEDEC MO-150 AE Iss. B							

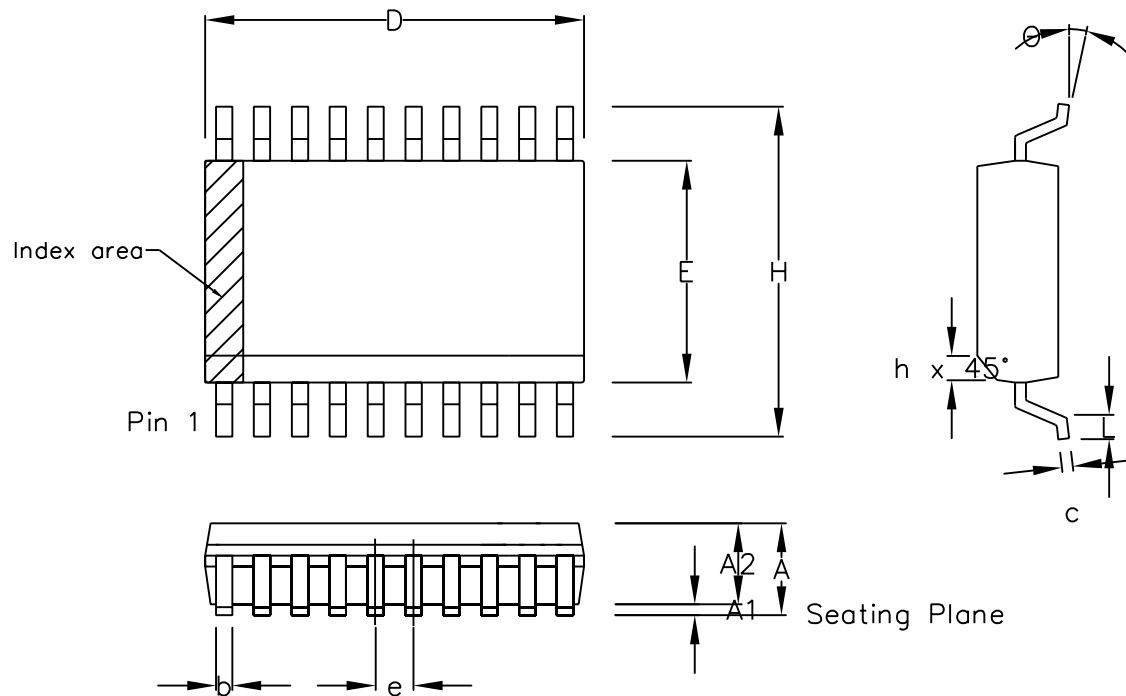
This drawing supersedes: –
418/ED/51481/002 (Swindon/Plymouth)

Notes:

1. A visual index feature, e.g. a dot, must be located within the cross-hatched area.
2. Controlling dimension are in millimeters.
3. Dimensions D and E1 do not include mould flash or protusion. Mould flash or protusion shall not exceed 0.20 mm per side. D and E1 are maximum plastic body size dimensions including mould mismatch.
4. Dimension b does not include dambar protusion/intrusion. Allowable dambar protusion shall be 0.13 mm total in excess of b dimension. Dambar intrusion shall not reduce dimension b by more than 0.07 mm.

© Zarlink Semiconductor 2002 All rights reserved.					Package Code DD	
ISSUE	1	2	3		Previous package codes NP / N	Package Outline for 20 lead SSOP (5.3mm Body Width)
ACN	201933	205234	212477			
DATE	27Feb97	25Sep98	3Apr02			GPD00294
APPRD.						





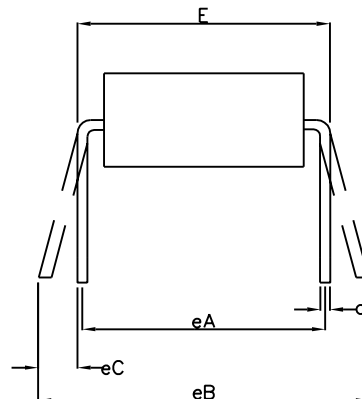
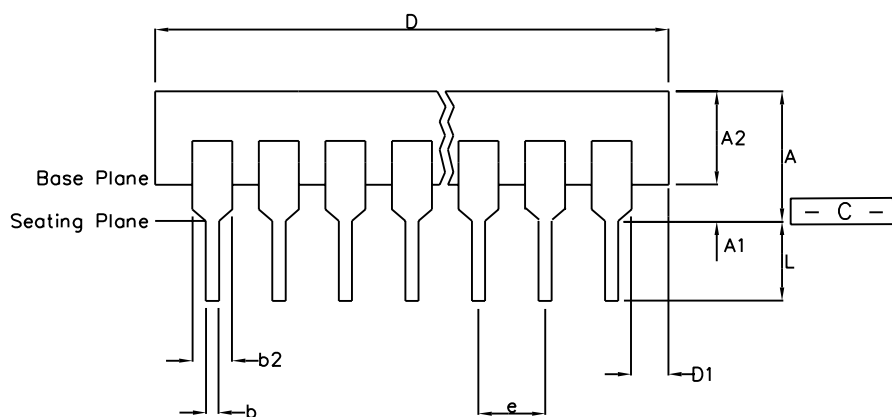
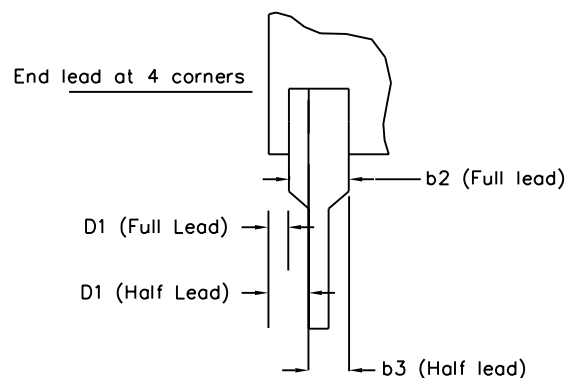
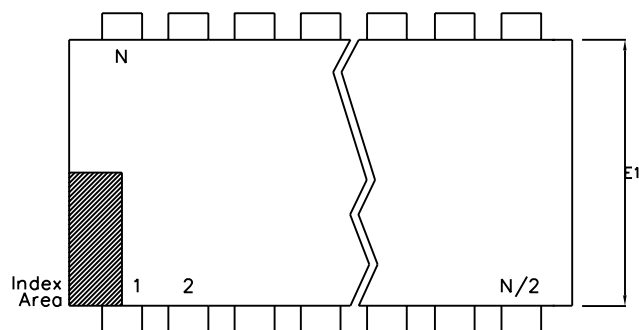
Symbol	Control Dimensions in millimetres			Altern. Dimensions in inches		
	MIN	Nominal	MAX	MIN	Nominal	MAX
A	2.35		2.65	0.093		0.104
A1	0.10		0.30	0.004		0.012
A2	2.25		2.35	0.089		0.092
D	12.60		13.00	0.496		0.512
H	10.00		10.65	0.394		0.419
E	7.40		7.60	0.291		0.299
L	0.40		1.27	0.016		0.050
e	1.27 BSC.			0.050 BSC.		
b	0.33		0.51	0.013		0.020
c	0.23		0.32	0.009		0.013
θ	0°		8°	0°		8°
h	0.25		0.75	0.010		0.029
	Pin features					
N	20					
Conforms to JEDEC MS-013AC Iss. C						

Notes:

1. The chamfer on the body is optional. If it not present, a visual index feature, e.g. a dot, must be located within the cross-hatched area.
2. Controlling dimension are in millimeters.
3. Dimension D do not include mould flash, protrusion or gate burrs. These shall not exceed 0.006" per side.
4. Dimension E1 do not include inter-lead flash or protrusion. These shall not exceed 0.010" per side.
5. Dimension b does not include dambar protrusion/intrusion. Allowable dambar protrusion shall be 0.004" total in excess of b dimension.

© Zarlink Semiconductor 2002 All rights reserved.					Package Code DC	
ISSUE	1	2	3		Previous package codes MP / S	Package Outline for 20 lead SOIC (0.300" Body Width)
ACN	6746	201941	213098			
DATE	7Apr95	27Feb97	15Jul02			GPD00015
APPRD.						





	Min mm	Max mm	Min Inches	Max Inches
A		5.33		0.210
A1	0.38		0.015	
A2	2.92	4.95	0.115	0.195
b	0.36	0.56	0.014	0.022
b2	1.14	1.78	0.045	0.070
b3	n/a	n/a	n/a	n/a
c	0.20	0.36	0.008	0.014
D	24.89	26.92	0.980	1.060
D1	0.13		0.005	
E	7.62	8.26	0.300	0.325
E1	6.10	7.11	0.240	0.280
e	2.54	BSC	0.100	BSC
eA	7.62	BSC	0.300	BSC
eB		10.92		0.430
eC	0.00	1.52	0.000	0.060
L	2.92	3.81	0.115	0.150
N	20		20	
Conforms to Jedec MS-001AD Issue D				

Notes:

1. Dimensions D, D1 & E1 do not include mould flash or protrusions.
2. Dimensions E & eA are measured with leads constrained to be perpendicular to datum $\text{--- } \bar{C} \text{ ---}$
3. Dimensions eB & eC are measured with the leads unconstrained
4. Controlling dimensions are Inches. Millimeter conversions are not necessarily exact.
5. N is the maximum of terminal positions.

This drawing supersedes: -
UK drawing # 418/ED/39502/005

© Zarlink Semiconductor 2002 All rights reserved.					Package Code DA	
ISSUE	1	2			Previous package codes DP / E	Package Outline for 20 lead PDIP
ACN	202562	213107				
DATE	9Jun97	15Jul02				GPD00347
APPRD.						





**For more information about all Zarlink products
visit our Web Site at
www.zarlink.com**

Information relating to products and services furnished herein by Zarlink Semiconductor Inc. or its subsidiaries (collectively "Zarlink") is believed to be reliable. However, Zarlink assumes no liability for errors that may appear in this publication, or for liability otherwise arising from the application or use of any such information, product or service or for any infringement of patents or other intellectual property rights owned by third parties which may result from such application or use. Neither the supply of such information or purchase of product or service conveys any license, either express or implied, under patents or other intellectual property rights owned by Zarlink or licensed from third parties by Zarlink, whatsoever. Purchasers of products are also hereby notified that the use of product in certain ways or in combination with Zarlink, or non-Zarlink furnished goods or services may infringe patents or other intellectual property rights owned by Zarlink.

This publication is issued to provide information only and (unless agreed by Zarlink in writing) may not be used, applied or reproduced for any purpose nor form part of any order or contract nor to be regarded as a representation relating to the products or services concerned. The products, their specifications, services and other information appearing in this publication are subject to change by Zarlink without notice. No warranty or guarantee express or implied is made regarding the capability, performance or suitability of any product or service. Information concerning possible methods of use is provided as a guide only and does not constitute any guarantee that such methods of use will be satisfactory in a specific piece of equipment. It is the user's responsibility to fully determine the performance and suitability of any equipment using such information and to ensure that any publication or data used is up to date and has not been superseded. Manufacturing does not necessarily include testing of all functions or parameters. These products are not suitable for use in any medical products whose failure to perform may result in significant injury or death to the user. All products and materials are sold and services provided subject to Zarlink's conditions of sale which are available on request.

Purchase of Zarlink's I²C components conveys a licence under the Philips I²C Patent rights to use these components in and I²C System, provided that the system conforms to the I²C Standard Specification as defined by Philips.

Zarlink, ZL and the Zarlink Semiconductor logo are trademarks of Zarlink Semiconductor Inc.

Copyright Zarlink Semiconductor Inc. All Rights Reserved.

TECHNICAL DOCUMENTATION - NOT FOR RESALE
